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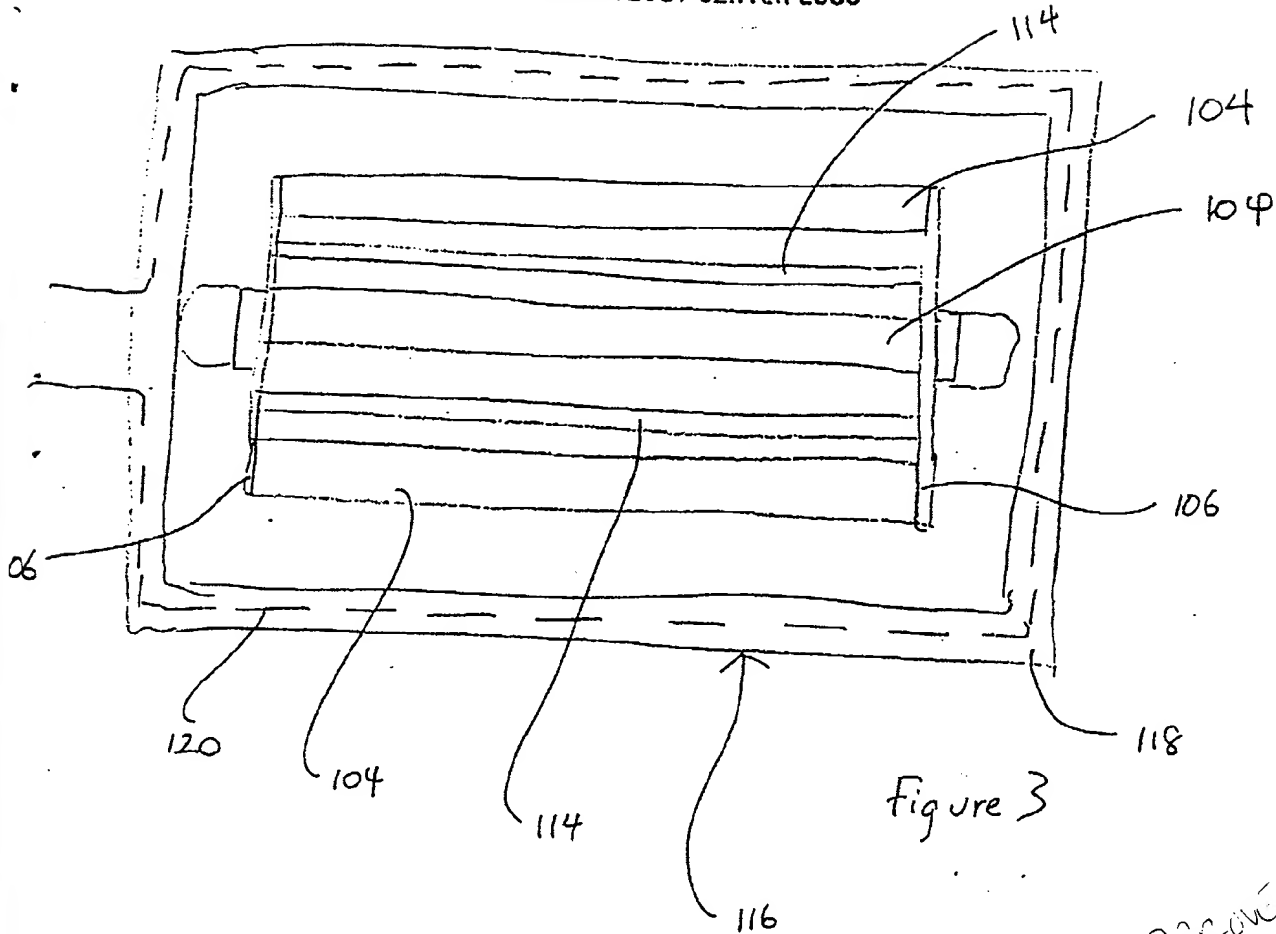


Figure 3

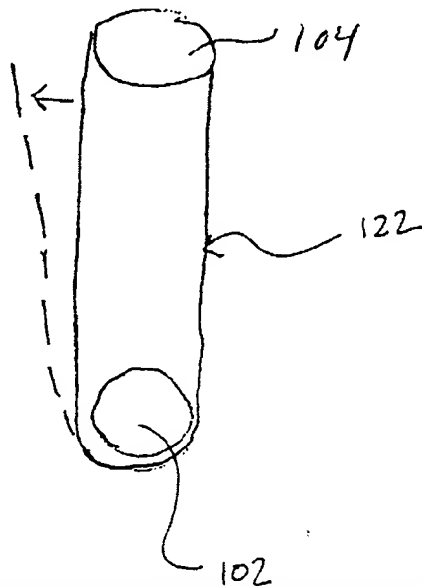


Figure 4

Approved  
DL  
5/2/03